

# Electronics Packaging & Reliability Society Joint Chapter: Reported by: Professor Chris Bailey



## **Key Achievements and member value/services**

- Prof Bailey appointment as EPS President
- Two Events in collaboration with IMAPS-UK
  - Microtech – Power in Packaging (April 2019)
  - IoT Workshop (February 2019)
  - Organising/ Contributions to International events : ECTC (USA); EPTC (Singapore)
- Development of EPS society strategic plan
  - <https://eps.ieee.org/about/governance.html>
- Contributions to IEEE HIR Roadmap
  - <https://eps.ieee.org/technology/heterogeneous-integration-roadmap.html>

## **Current plan of activities**

- Implement EPS strategic Plan
- Contribute to second edition of IEEE HIR Roadmap
- Manage the EPS Society activities worldwide
- Events:
  - Continue collaboration with IMAPS-UK
  - Contribute to BICOP (in collaboration with UK Photonics Chapter)
  - Thermal management workshop (UK Power Electronics & IET)
- Refresh committee members

## **Focus areas (2020-2021)**

Goals	KPIs	Challenges to reach KPIs/ Resources
Conferences & Events (Includes BICOP)	Increase attendance and awareness of packaging/ reliability (Links with industry)	COVID-19 IEEE Support on virtual events
Membership/Affiliates	Increase UK membership > 120	Costs of IEEE membership